

Features

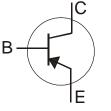
- Ultra-Small Leadless Surface Mount Package
- Complementary NPN Type Available (2DC4617QLP)
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free, "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

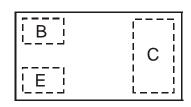
- Case: DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound. • UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020 •
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0008 grams (approximate)



Bottom View



Device Symbol



Top View Device Schematic

Ordering Information (Note 3)

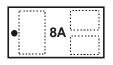
Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
2DA1774QLP-7	8A	7	8	3,000
2DA1774QLP-7B	8A	7	8	10,000

Notes: 1. No purposefully added lead.

Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
For packaging details, go to our website at http://www.diodes.com.

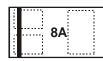
Marking Information

2DA1774QLP-7



Top View Dot Denotes Collector Side

2DA1774QLP-7B



Top View

Bar Denotes Base and Emitter Side

8A = Product Type Marking Code



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current - Continuous	Ic	-100	mA
Peak Collector Current	Ісм	-200	mA

Thermal Characteristics

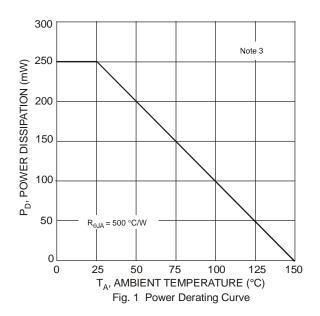
Characteristic	Symbol	Value	Unit
Power Dissipation @T _A = 25°C (Note 4)	PD	250	mW
Thermal Resistance, Junction to Ambient $@T_A = 25^{\circ}C$ (Note 4)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

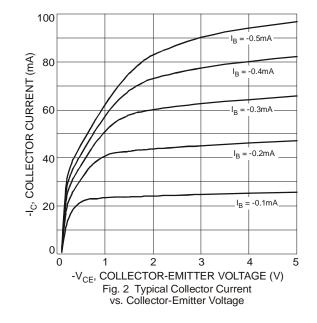
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)					
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-50		V	$I_{C} = -50 \mu A$, $I_{E} = 0$
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	-40		V	$I_{\rm C} = -1 {\rm mA}, \ I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-5.0		V	$I_{\rm E} = -50 \mu A, I_{\rm C} = 0$
Collector Cutoff Current	I _{CBO}	_	-100	nA	$V_{CB} = -30V$
			-5	μΑ	$V_{CB} = -30V, T_A = 150^{\circ}C$
Emitter Cutoff Current	I _{EBO}		-100	nA	$V_{EB} = -4.0V$
ON CHARACTERISTICS (Note 5)					
DC Current Gain	h _{FE}	120	270		$V_{CE} = -6.0V, I_{C} = -1.0mA$
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		-0.2	V	$I_{C} = -50 \text{mA}, I_{B} = -5.0 \text{mA}$
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{obo}		5.0	pF	$V_{CB} = -12V, f = 1.0MHz, I_E = 0$
Current Gain-Bandwidth Product	f _T	100	_	MHz	$V_{CE} = -12V, I_C = -2.0mA, f = 100MHz$

Notes:

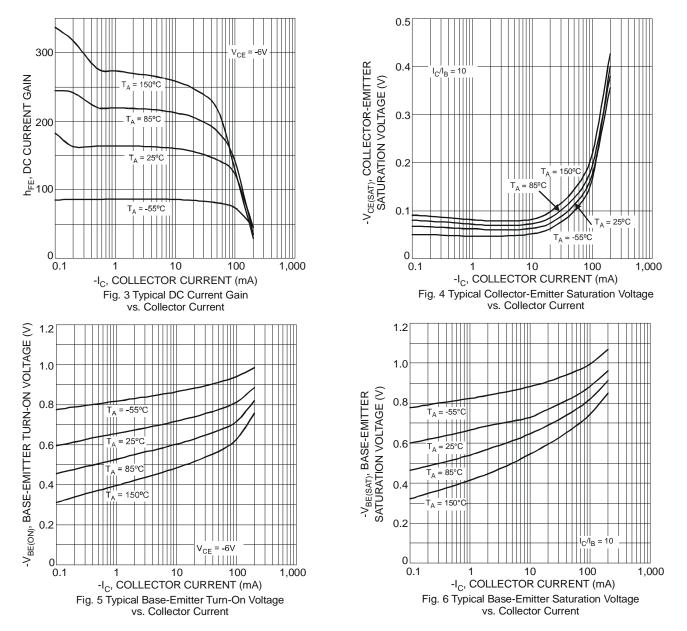
4. Part mounted on FR-4 PCB with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 5. Short duration pulse test used to minimize self-heating effect.



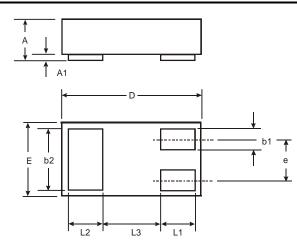




2DA1774QLP



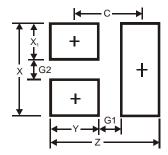
Package Outline Dimensions



DFN1006-3				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0	0.05	0.03	
b1	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
D	0.95	1.075	1.00	
ш	0.55	0.675	0.60	
е			0.35	
L1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3	_	_	0.40	
All Dimensions in mm				



Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Y	0.4
С	0.7

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